MJH6284 (NPN), MJH6287 (PNP)

Darlington Complementary Silicon Power Transistors

These devices are designed for general−purpose amplifier and low−speed switching motor control applications.

Features

- Similar to the Popular NPN 2N6284 and the PNP 2N6287
- Rugged RBSOA Characteristics
- Monolithic Construction with Built−in Collector−Emitter Diode
- These are Pb−Free Devices*

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Collector−Emitter Voltage	V_{CEO}	100	Vdc
Collector−Base Voltage	V_{CB}	100	Vdc
Emitter−Base Voltage	V_{EB}	5.0	Vdc
Collector Current − Continuous − Peak	I_C	20 40	Adc
Base Current	I_B	0.5	Adc
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_D	160 1.28	W W/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}	−65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction−to−Case	$R_{\theta JC}$	0.78	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

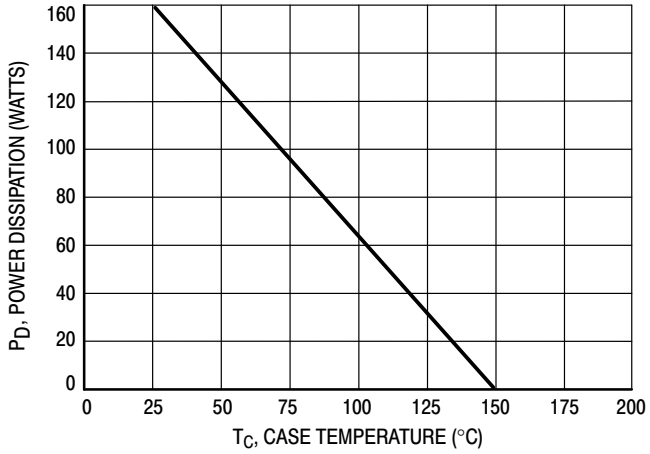

Figure 1. Power Derating

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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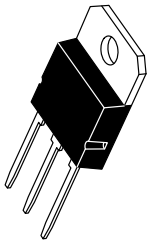
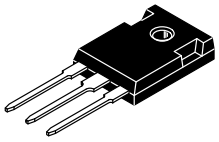
DARLINGTON 20 AMPERE COMPLEMENTARY SILICON POWER TRANSISTORS 100 VOLTS, 160 WATTS



SOT−93 (TO−218) CASE 340D



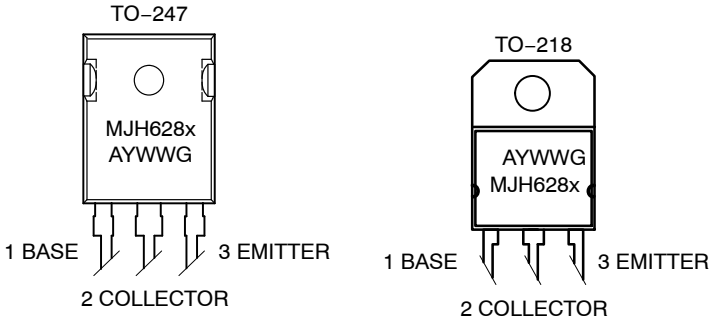
TO−247 CASE 340L STYLE 3

NOTE: Effective June 2012 this device will be available only in the TO−247 package. Reference FPCN# 16827.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

MARKING DIAGRAMS



MJH628x = Device Code
x = 4 or 7
A = Assembly Location
Y = Year
WW = Work Week
G = Pb−Free Package

ORDERING INFORMATION

Device Order Number	Package Type	Shipping
MJH6284G	TO−218 (Pb−Free)	30 Units / Rail
MJH6287G	TO−218 (Pb−Free)	30 Units / Rail
MJH6284G	TO−247 (Pb−Free)	30 Units / Rail
MJH6287G	TO−247 (Pb−Free)	30 Units / Rail

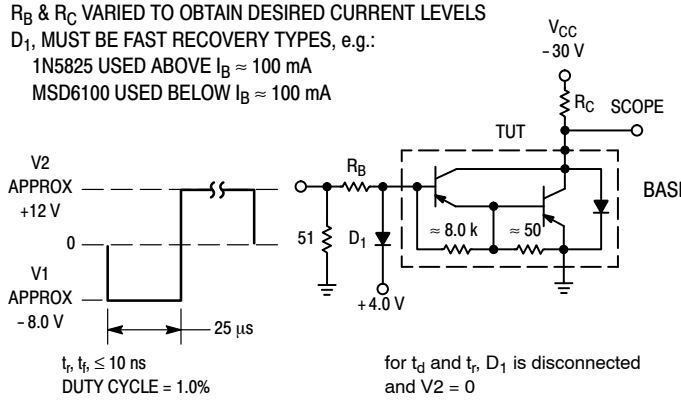
ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector−Emitter Sustaining Voltage (I_C = 0.1 Adc, I_B = 0)	$V_{CEO(sus)}$	100	–	Vdc
Collector Cutoff Current (V_{CE} = 50 Vdc, I_B = 0)	I_{CEO}	–	1.0	mAdc
Collector Cutoff Current (V_{CE} = Rated V_{CB}, $V_{BE(off)}$ = 1.5 Vdc) (V_{CE} = Rated V_{CB}, $V_{BE(off)}$ = 1.5 Vdc, T_C = 150°C)	I_{CEX}	 – –	 0.5 5.0	mAdc
Emitter Cutoff Current (V_{BE} = 5.0 Vdc, I_C = 0)	I_{EBO}	–	2.0	mAdc
ON CHARACTERISTICS (Note 1)				
DC Current Gain (I_C = 10 Adc, V_{CE} = 3.0 Vdc) (I_C = 20 Adc, V_{CE} = 3.0 Vdc)	h_{FE}	 750 100	 18,000 –	–
Collector−Emitter Saturation Voltage (I_C = 10 Adc, I_B = 40 mAdc) (I_C = 20 Adc, I_B = 200 mAdc)	$V_{CE(sat)}$	 – –	 2.0 3.0	Vdc
Base−Emitter On Voltage (I_C = 10 Adc, V_{CE} = 3.0 Vdc)	$V_{BE(on)}$	–	2.8	Vdc
Base−Emitter Saturation Voltage (I_C = 20 Adc, I_B = 200 mAdc)	$V_{BE(sat)}$	–	4.0	Vdc
DYNAMIC CHARACTERISTICS				
Current−Gain Bandwidth Product (I_C = 10 Adc, V_{CE} = 3.0 Vdc, f = 1.0 MHz)	f_T	4.0	–	MHz
Output Capacitance (V_{CB} = 10 Vdc, I_E = 0, f = 0.1 MHz) MJH6284 MJH6287	C_{ob}	 – –	 400 600	pF
Small−Signal Current Gain (I_C = 10 Adc, V_{CE} = 3.0 Vdc, f = 1.0 kHz)	h_{fe}	300	–	–

SWITCHING CHARACTERISTICS

Resistive Load		Symbol	Typical NPN	Typical PNP	Unit
Delay Time	V_{CC} = 30 Vdc, I_C = 10 Adc I_{B1} = I_{B2} = 100 mA Duty Cycle = 1.0%	t_d	0.1	0.1	μs
Rise Time		t_r	0.3	0.3	
Storage Time		t_s	1.0	1.0	
Fall Time		t_f	3.5	2.0	

1. Pulse test: Pulse Width = 300 μs, Duty Cycle = 2.0%.



For NPN test circuit reverse diode and voltage polarities.

Figure 2. Switching Times Test Circuit

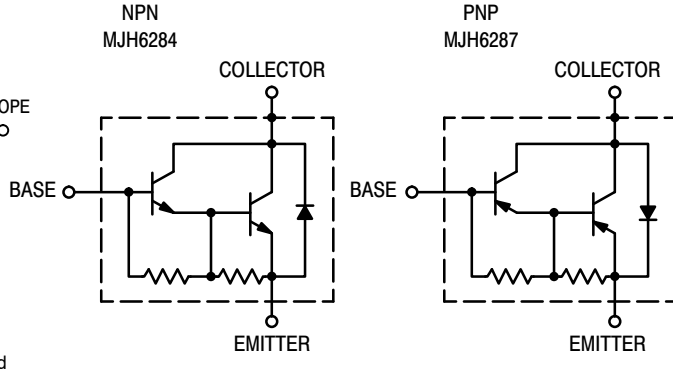


Figure 3. Darlington Schematic

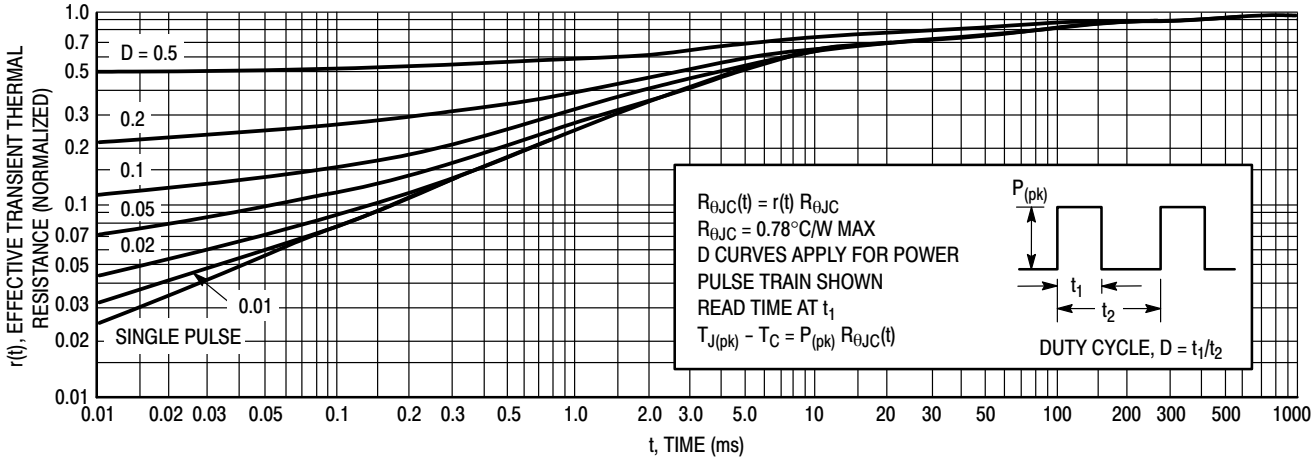


Figure 4. Thermal Response

FBSOA, FORWARD BIAS SAFE OPERATING AREA

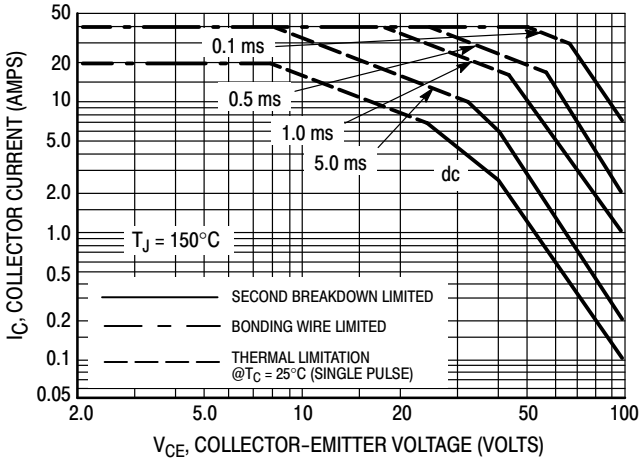


Figure 5. MJH6284, MJH6287

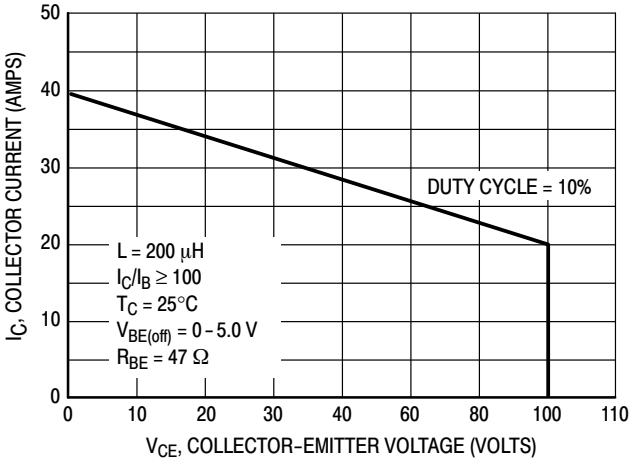


Figure 6. Maximum RBSOA, Reverse Bias Safe Operating Area

FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on $T_{J(pk)}$ = 150°C; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \leq 150°C$. $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

NPN **PNP**

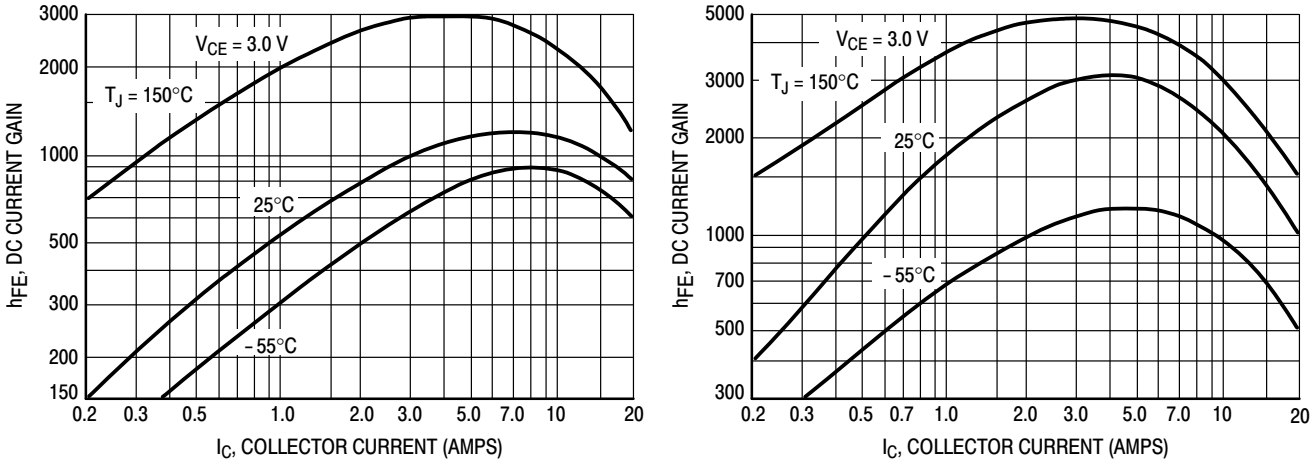


Figure 7. DC Current Gain

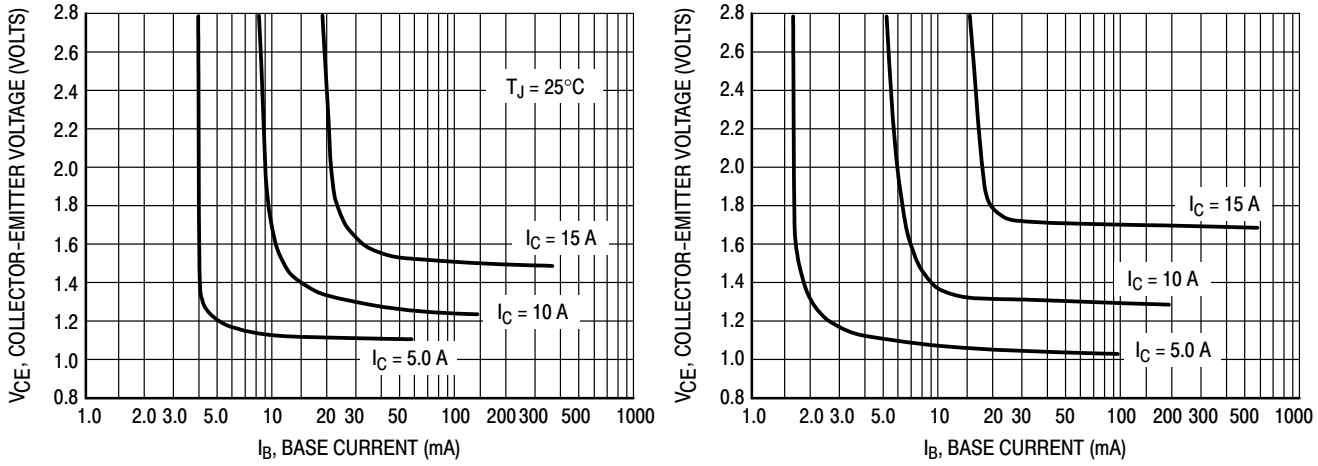


Figure 8. Collector Saturation Region

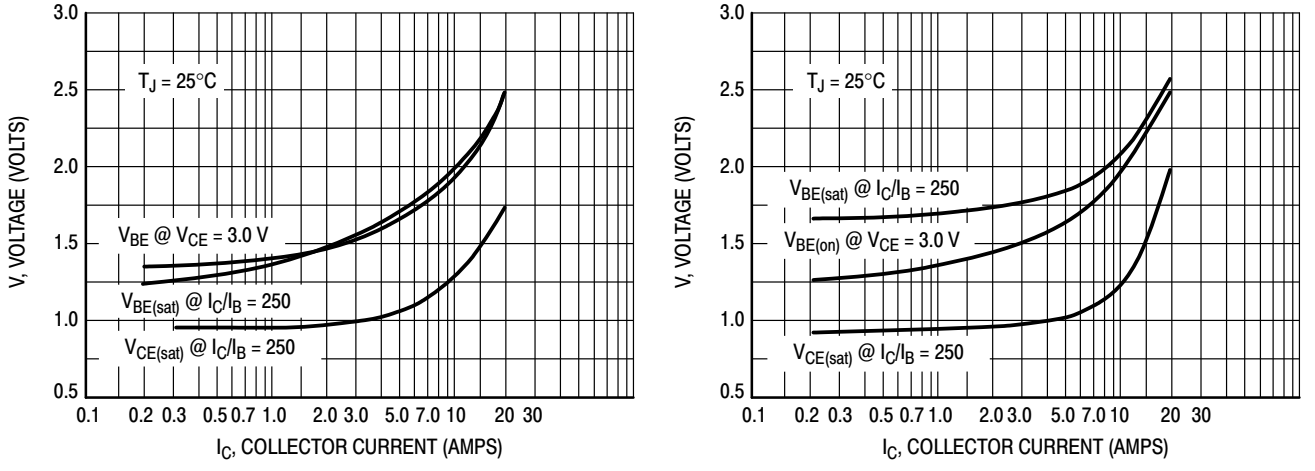
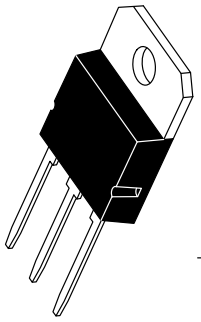


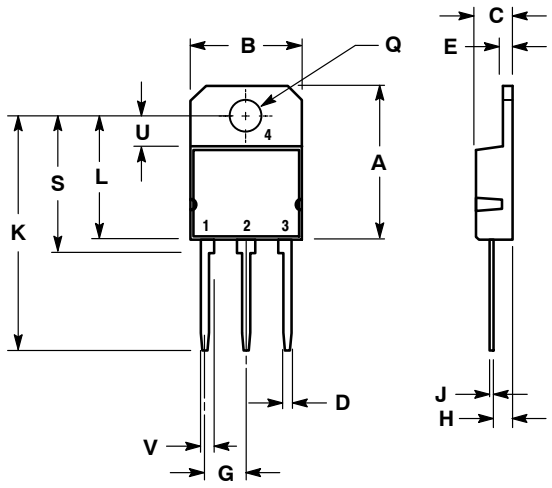
Figure 9. “On” Voltages

SOT−93 (TO−218)
CASE 340D−02
ISSUE E

DATE 03 JAN 2002



SCALE 1:1



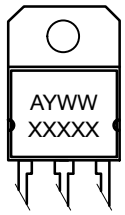
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	---	20.35	---	0.801
B	14.70	15.20	0.579	0.598
C	4.70	4.90	0.185	0.193
D	1.10	1.30	0.043	0.051
E	1.17	1.37	0.046	0.054
G	5.40	5.55	0.213	0.219
H	2.00	3.00	0.079	0.118
J	0.50	0.78	0.020	0.031
K	31.00 REF		1.220 REF	
L	---	16.20	---	0.638
Q	4.00	4.10	0.158	0.161
S	17.80	18.20	0.701	0.717
U	4.00 REF		0.157 REF	
V	1.75 REF		0.069	

STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

STYLE 2:
PIN 1. ANODE
2. CATHODE
3. ANODE
4. CATHODE

GENERIC MARKING DIAGRAM*



A = Assembly Location
Y = Year
WW = Work Week
XXXXX = Device Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.

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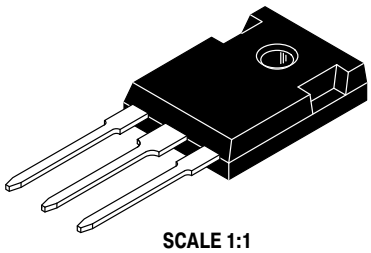
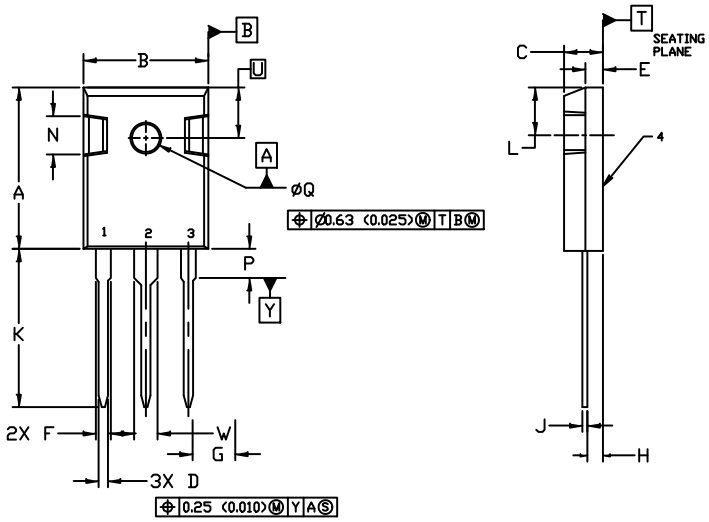


SCALE 1:1

TO−247
CASE 340L
ISSUE G

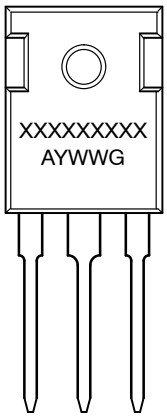
DATE 06 OCT 2021



NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER

	MILLIMETERS		INCHES	
DIM	MIN.	MAX.	MIN.	MAX.
A	20.32	21.08	0.800	0.830
B	15.75	16.26	0.620	0.640
C	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
E	1.90	2.60	0.075	0.102
F	1.65	2.13	0.065	0.084
G	5.45 BSC		0.215 BSC	
H	1.50	2.49	0.059	0.098
J	0.40	0.80	0.016	0.031
K	19.81	20.83	0.780	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
P	----	4.50	----	0.177
Q	3.55	3.65	0.140	0.144
U	6.15 BSC		0.242 BSC	
W	2.87	3.12	0.113	0.123

GENERIC MARKING DIAGRAM*



STYLE 1:
PIN 1. GATE
2. DRAIN
3. SOURCE
4. DRAIN

STYLE 2:
PIN 1. ANODE
2. CATHODE (S)
3. ANODE 2
4. CATHODES (S)

STYLE 3:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

STYLE 4:
PIN 1. GATE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

STYLE 5:
PIN 1. CATHODE
2. ANODE
3. GATE
4. ANODE

STYLE 6:
PIN 1. MAIN TERMINAL 1
2. MAIN TERMINAL 2
3. GATE
4. MAIN TERMINAL 2

XXXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.

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